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(54) Title of the invention : Method of preparation and structural with compositional analysis of vacuum evaporated Lead Phthalocyanine Thin films

<ul> <li>(51) International classification</li> <li>(86) International Application No Filing Date</li> <li>(87) International Publication No</li> <li>(61) Patent of Addition to Application Number Filing Date</li> <li>(62) Divisional to Application Number Filing Date</li> </ul>	:H01L0051000000, C22C0038400000, C08G0077520000, C08G0065400000, C30B0029520000 :PCT// :01/01/1900 : NA :NA :NA :NA :NA :NA	<ul> <li>1)Dr P KALUGASALAM Address of Applicant :Anna University Regional Campus Coimbatore Navavoor Vadavalli</li></ul>
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(57) Abstract :

Because of its unique structural and electrical properties, Lead Phthalocyanine (PbPc) has received some attention in Phthalocyanine research. PbPc is a desirable material for a variety of device applications, including optoelectronics, gas sensors, organic light emitting devices (OLEDs), field effect transistors (FETs), and so on. On a glass substrate, the films were 150 nm, 300 nm, and 450 nm thick, and on a potassium chloride (KCl) substrate, they were 150 nm thick. The film is annealed at temperatures of 323 K and 373 K to a thickness of 450 nm. The patterns at lower thickness (150 nm) reveal peaks at 2 values 6.850, 14.160, and 24.550, which were ascribed to monoclinic (001), (320), and (111) lines, respectively, according to the X-ray diffraction results. The film thickness of 450 nm is annealed at temperatures of 323 K and 373 K. Peaks at 2 values of 14.90, 22.40, and 30.30 are attributed to the triclinic (200), (300), and (400) lines, respectively, when annealed at 323 K. The EDAX approach was used to analysePbPc films formed at various thicknesses, substrates, and annealing temperatures. In both circumstances, the percent go fead is the same, and the amount is quite small (1.35%). When annealed at a high temperature, the proportion of carbon increases from 65.56 percent to 84.81 percent. FT-IR was used to determine the elemental composition of PbPc films formed at various thicknesses and annealed temperatures. The intensity of the C-C and C-H benzene ring peaks increases with thickness and temperature.

No. of Pages : 24 No. of Claims : 4



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## (54) Title of the invention : STOCHASTIC MODELING AND QUANTIFICATION OF UNCERTAINTIES IN NOMINALLY IDENTICAL STRUCTURES

(51) International classification (86) International Application No Filing Date (87) International Publication No (61) Patent of Addition to Application Number Filing Date (62) Divisional to Application Number Filing Date	:G06F0030230000, G01N0033200000, E21B0049000000, G05B0019418000, G06F0111080000 :NA :NA :NA :NA :NA :NA :NA	<ul> <li>(7) I.Name of Applicant :</li> <li>IDP.TRENDRA RUMAR CHAUHAN</li> <li>Address of Applicant : PROFESSOR DEPARTMENT OF MATHEMATICS DR KN MODI INSTITUTE</li> <li>OF ENGINEERING AND TECHNOLOGY, MODINAGAR, GHAZIABAD, UTTAR PRADESH – 201204</li> <li>MODINAGAR</li></ul>
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(57) Abstract :

This work investigated and characterized the influence of the variability of geometric and material properties on the dynamic response of nominally identical structural components in isolation and in a system composed of a set of these components. In addition, the importance of an analysis for the assembly of structures was shown due to the changes in dynamic behavior due to the assembly order. At first, in a simplified analysis, 3 factors that can influence the dynamic behavior of a structure were analyzed, which cause relevant changes both in natural frequencies and in modes. Subsequently, a more complex component, in the form of a frame, was introduced to be identified experimentally and, after compatibility with numerical analysis, to have its dimensional and material parameters analyzed in order to discover the relevance of each parameter in the dynamic behavior of the component. In addition, the assemblies between the components were also investigated, for comparison with the dynamic behavior of the components, and the influence of the assembly factor on the variability of the response. It can be seen, in general, that the variability of assembly parameters, resulting from the reduction of costs with the reduction of tolerances, can be a decisive factor in the operational scope of the work, which can be even more aggravated when assembly variability is considered. However, with computational use to predict behaviors, such as sensitivity analysis to define relevant parameters for the system, selective assembly to select the best configurations that promote the best responses, Monte-Carlo simulations, among others, these problems can be solved guaranteeing the economy of more complex works.

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